

Docket No. 45475-000

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Sung Sik Jang	RECE JUL 2 C 2800
Serial No.: 09/687493	Examiner: Alexander Williams
Confirmation No.	Root
Filed: October 13, 2000	) Group Art Unit: 2826

SEMICONDUCTOR PACKAGE HAVING IMPROVED ADHESIVENESS AND For: **GROUND BONDING** 

Assistant Commissioner for Patents Washington, DC 20231

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited postage paid with the United States Postal Service as first class mail in an envelope Commissioner for Patents, Washington, DC 20231

Dear Sir:

## **AMENDMENT**

Responsive to the Office Action dated January 24, 2002, please amend the aboveidentified application for patent as follows:

07/19/2002 GWDRDOF1 0000002 09687493

IN THE SPECIFICATION

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> Please substitute the specification as attached hereto in EXHIBIT A. A marked-up version of the substitute specification is attached as **EXHIBIT B** to this Amendment. The substitute specification is submitted herewith under 37 CFR 1.121 and 1.125. No new matter has been added.

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